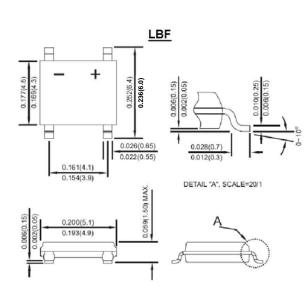
## TB1M~TB10M

### Surface Mount Flat Bridge Rectifier Reverse Voltage - 100 to 1000 V Forward Current - 1 A

#### Features

- · Ideal for printed circuit board
- · Glass passivated chip
- Reliable low cost construction utilizing molded
  plastic technique
- Small size, simple installation



#### **Mechanical Data**

- **Terminal**: Plated leads solderable per MIL-STD 202E, method 208C
- Case: UL-94 Class V-0 recognized flame retardant epoxy
- · Polarity: Polarity symbol marked on body

Dimensions in inches and (millimeters)

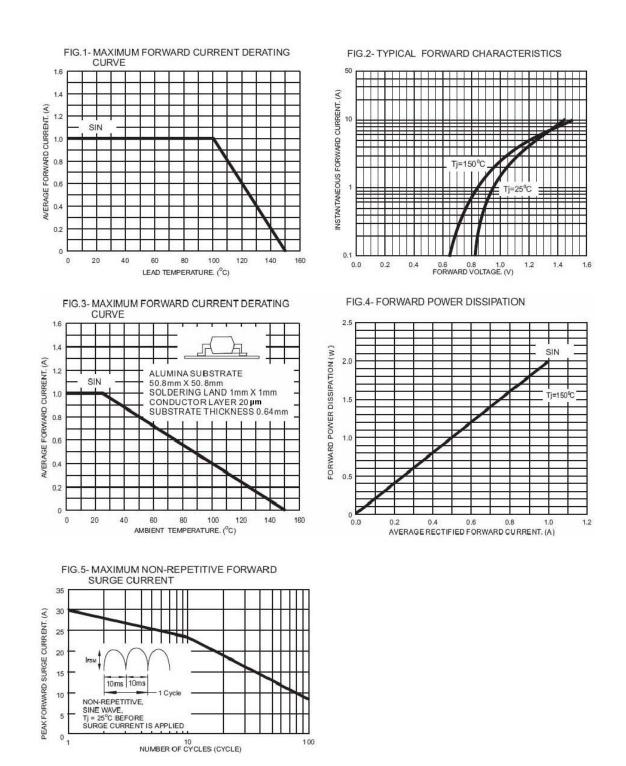
#### **Maximum Ratings and Electrical characteristics**

Single-phase, half-wave, 60 Hz, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20 %.

Parameter	Symbols	TB1M	TB2M	TB4M	TB6M	TB8M	TB10M	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current on Glass-expoxy P.C.B.	I <sub>F(AV)</sub>	1						А
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	30						А
Maximum Instantaneous Forward Voltage at Forward Current 0.4 A	V <sub>F</sub>	0.95					V	
Maximum DC Reverse Current $T_a = 25^{\circ}C$ at Rated DC Blocking Voltage $T_a = 125^{\circ}C$	I <sub>R</sub>	5 100					μA	
Typical Thermal Resistance Junction to Lead On Glass-expoxy P.C.B.	${f R}_{ heta JL} \ {f R}_{ heta JA}$	42 88						°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	- 55 to + 150					°C	



# **TOP DYNAMIC**





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